

HD74LS30 8-input Positive NAND Gate

REJ03D0404-0200 Rev.2.00 Feb.18.2005

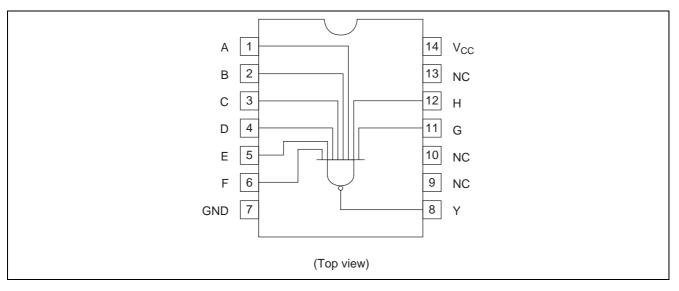
Features

• Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74LS30P	DILP-14 pin	PRDP0014AB-B (DP-14AV)	Р	_
HD74LS30FPEL	SOP-14 pin (JEITA)	PRSP0014DF-B (FP-14DAV)	FP	EL (2,000 pcs/reel)
HD74LS30RPEL	SOP-14 pin (JEDEC)	PRSP0014DE-A (FP-14DNV)	RP	EL (2,500 pcs/reel)

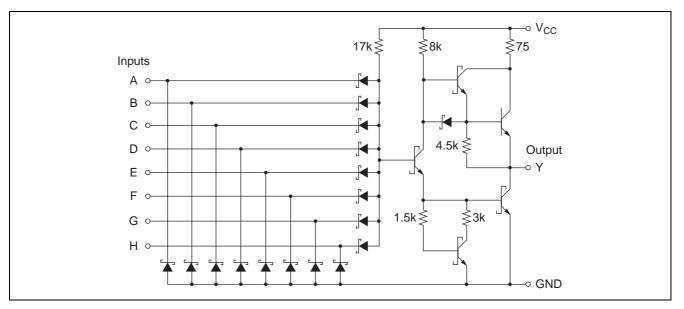
Note: Please consult the sales office for the above package availability.

Pin Arrangement





Circuit Schematic



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit
Supply voltage	V _{cc}	7	V
Input voltage	V _{IN}	7	V
Power dissipation	PT	400	mW
Storage temperature	Tstg	-65 to +150	°C

Note: Voltage value, unless otherwise noted, are with respect to network ground terminal.

Recommended Operating Conditions

Item	Symbol	Min	Тур	Max	Unit
Supply voltage	Vcc	4.75	5.00	5.25	V
Output ourront	I _{OH}	—	—	-400	μA
Output current	I _{OL}	—	—	8	mA
Operating temperature	Topr	-20	25	75	°C



Electrical Characteristics

 $(Ta = -20 \text{ to } +75 \ ^{\circ}\text{C})$

Symbol	min.	typ.*	max.	Unit	Condition
VIH	2.0			V	
V _{IL}	—		0.8	V	
V _{OH}	2.7			V	V_{CC} = 4.75 V, V_{IL} = 0.8 V, I_{OH} = –400 μA
V _{OL}	—		0.5	V	$I_{OL} = 8 \text{ mA}$ $V_{CC} = 4.75 \text{ V}, \text{ V}_{IH} = 2 \text{ V}$
	_		0.4	V	$I_{OL} = 4 \text{ mA}$ $V_{CC} = 4.75 \text{ V}, \text{ V}_{IH} = 2 \text{ V}$
IIн	—		20	μΑ	$V_{CC} = 5.25 \text{ V}, \text{ V}_{I} = 2.7 \text{ V}$
l _{IL}	_		-0.4	mA	$V_{CC} = 5.25 \text{ V}, \text{ V}_{I} = 0.4 \text{ V}$
l _l	—		0.1	mA	$V_{CC} = 5.25 \text{ V}, \text{ V}_{I} = 7 \text{ V}$
los	-20	_	-100	mA	V _{CC} = 5.25 V
ICCH	—	0.35	0.5	mA	V _{CC} = 5.25 V
ICCL		0.6	1.1	mA	V _{CC} = 5.25 V
VIK		—	-1.5	V	$V_{CC} = 4.75 \text{ V}, \text{ I}_{IN} = -18 \text{ mA}$
	VIH VIL VOH VOL IIH IIL II IOS ICCH ICCL	VIH 2.0 VIL — VOH 2.7 VOL — IIH — IIL — IIL — IOS —20 ICCH — ICCL —	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $

Note: $* V_{CC} = 5 V$, Ta = 25°C

Switching Characteristics

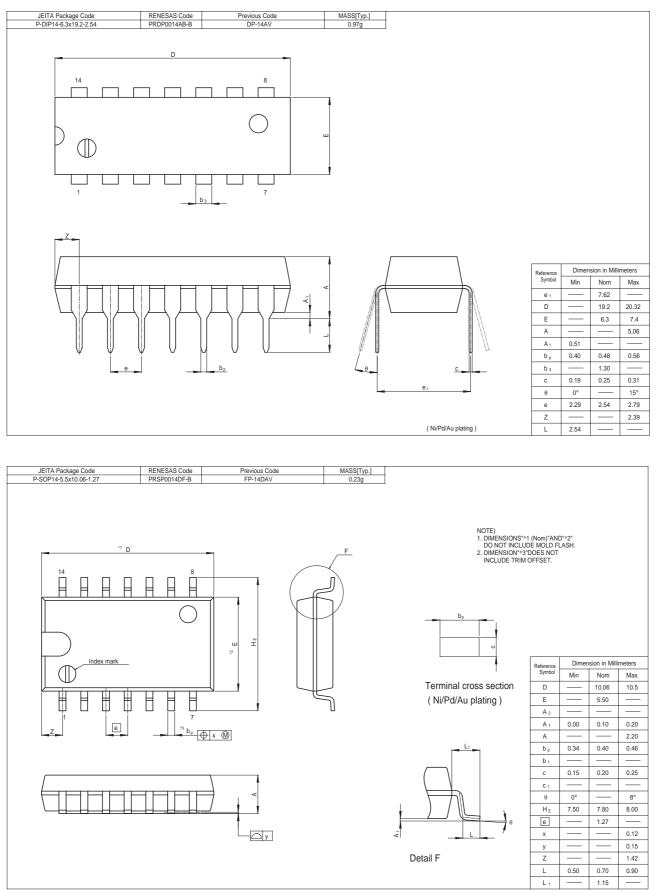
$(V_{CC} = 5 V)$	/, Ta =	25°C)
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Item	Symbol	min.	typ.	max.	Unit	Condition
Propagation delay time	t _{PLH}	_	8	15	ns	$C_L = 15 \text{ pF}, R_L = 2 \text{ k}\Omega$
	t _{PHL}		13	20	ns	$G_L = 15 \text{ pF}, \text{K}_L = 2 \text{K}\Omega$

Note: Refer to Test Circuit and Waveform of the Common Item "TTL Common Matter (Document No.: REJ27D0005-0100)".

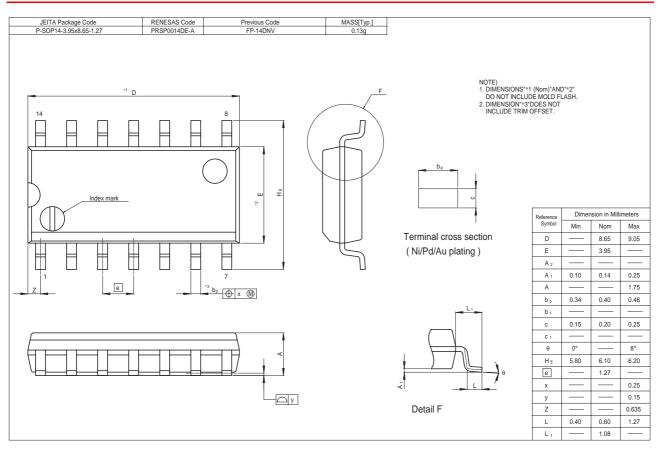


Package Dimensions





HD74LS30





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